

MITSUBISHI HVIGBT MODULES

CM600E2Y-34H

HIGH POWER SWITCHING USE
INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

CM600E2Y-34H



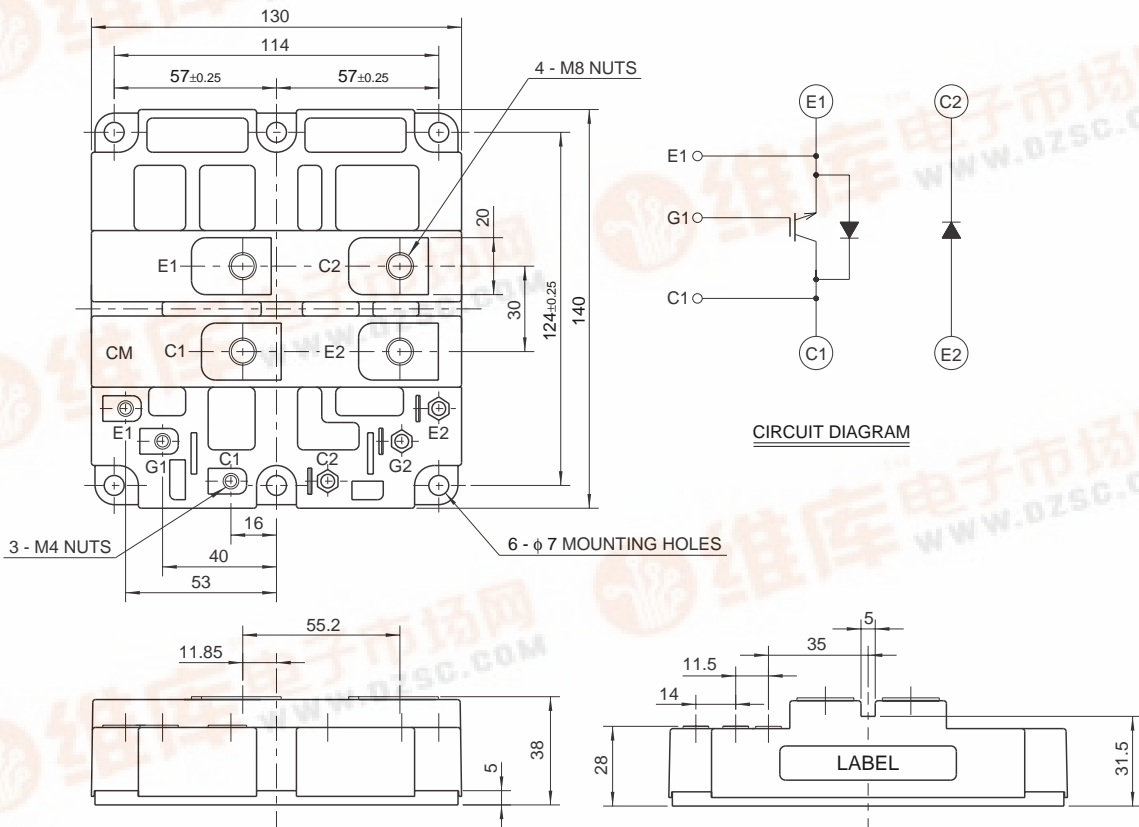
- Ic 600A
- VCES 1700V
- Insulated Type
- 1-elements in a pack (for brake)

APPLICATION

DC choppers, Dynamic braking choppers.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



HVIGBT MODULES (High Voltage Insulated Gate Bipolar Transistor Modules)



CM600E2Y-34H

HIGH POWER SWITCHING USE
INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS (T_j = 25°C)

Symbol	Item	Conditions	Ratings	Unit
V _{CE}	Collector-emitter voltage	V _{GE} = 0V	1700	V
V _{GE}	Gate-emitter voltage	V _{CE} = 0V	±20	V
I _C	Collector current	T _C = 25°C	600	A
I _{CM}		Pulse (Note 1)	1200	A
I _E (Note 2)	Emitter current	T _C = 25°C	600	A
I _{EM} (Note 2)		Pulse (Note 1)	1200	A
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C, IGBT part	6200	W
T _j	Junction temperature	—	-40 ~ +150	°C
T _{stg}	Storage temperature	—	-40 ~ +125	°C
V _{iso}	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1min.	4000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N·m
		Mounting screw M6	2.84 ~ 6.00	N·m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N·m
—	Mass	Typical value	1.5	kg

ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Symbol	Item	Conditions	Limits			Unit	
			Min	Typ	Max		
I _{CE}	Collector cutoff current	V _{CE} = V _{CE} , V _{GE} = 0V	—	—	12	mA	
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 60mA, V _{CE} = 10V	4.5	5.5	6.5	V	
I _{GE}	Gate-leakage current	V _{GE} = V _{GE} , V _{CE} = 0V	—	—	0.5	μA	
V _{CE(sat)}	Collector-emitter saturation voltage	T _j = 25°C	—	2.75	3.58	V	
		T _j = 125°C	—	3.30	—		
C _{ies}	Input capacitance	V _{CE} = 10V	—	70	—	nF	
C _{oes}	Output capacitance		V _{GE} = 0V	—	10.0	—	nF
C _{res}	Reverse transfer capacitance		—	—	3.8	—	nF
Q _G	Total gate charge	V _{CC} = 850V, I _C = 600A, V _{GE} = 15V	—	3.3	—	μC	
t _{d(on)}	Turn-on delay time	V _{CC} = 850V, I _C = 600A	—	—	1.20	μs	
t _r	Turn-on rise time	V _{GE1} = V _{GE2} = 15V	—	—	1.50	μs	
t _{d(off)}	Turn-off delay time	R _G = 3.3Ω	—	—	2.00	μs	
t _f	Turn-off fall time	Resistive load switching operation	—	—	0.60	μs	
V _{EC} (Note 2)	Emitter-collector voltage	I _E = 600A, V _{GE} = 0V	—	2.40	3.12	V	
t _{rr} (Note 2)	Reverse recovery time	I _E = 600A	—	—	2.00	μs	
Q _{rr} (Note 2)	Reverse recovery charge	die / dt = -1200A / μs	—	100	—	μC	
R _{th(j-c)Q}	Thermal resistance	Junction to case, IGBT part	—	—	0.020	K/W	
R _{th(j-c)R}		Junction to case, FWDI part	—	—	0.064	K/W	
R _{th(c-f)}	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/2 module)	—	0.016	—	K/W	
V _{FM}	Forward voltage	I _F = 600A, Clamp diode part	—	2.50	3.25	V	
t _{rr}	Reverse recovery time	I _F = 600A	—	—	2.00	μs	
Q _{rr}	Reverse recovery charge	di / dt = -1200A / μs, Clamp diode part	—	100	—	μC	
R _{th(j-c)}	Thermal resistance	Junction to case, Clamp diode part	—	—	0.064	K/W	
R _{th(c-f)}	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/2 module)	—	0.016	—	K/W	

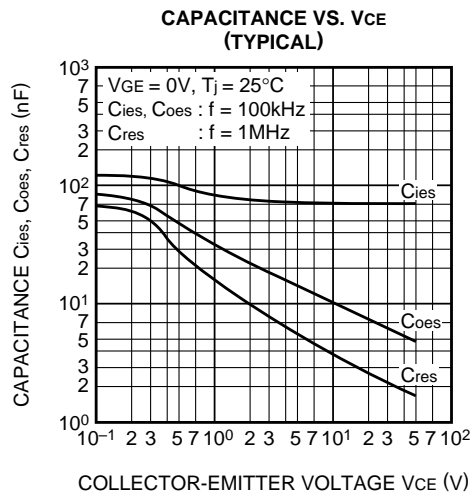
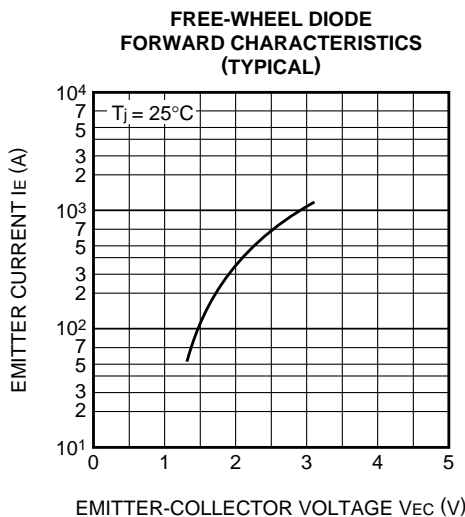
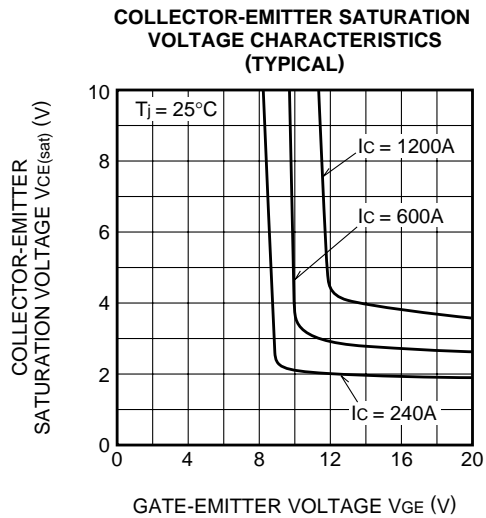
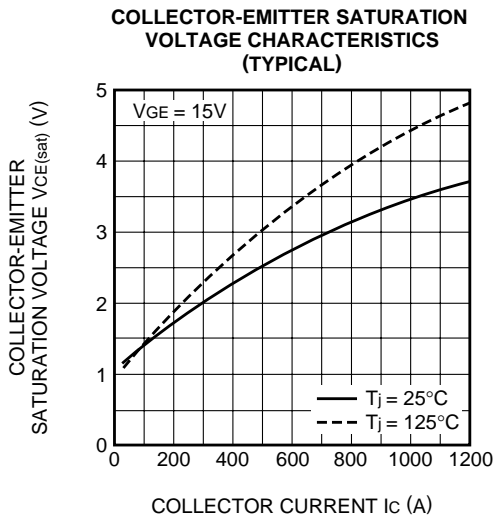
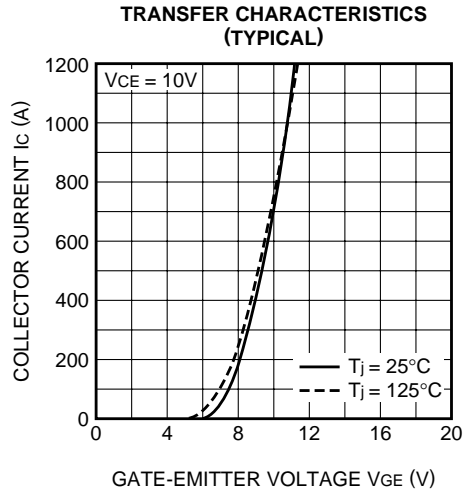
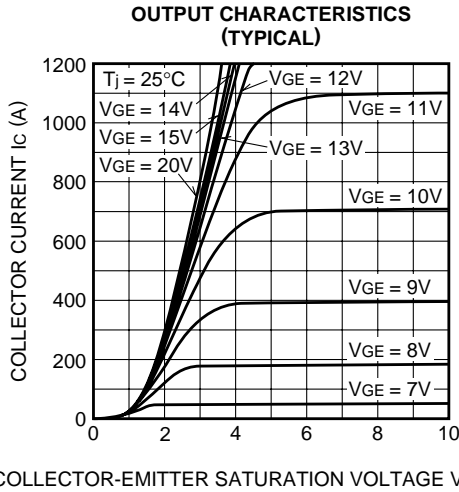
- Note 1. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.
 2. I_E, V_{EC}, t_{rr}, Q_{rr} & di/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.
 3. Junction temperature (T_j) should not increase beyond 150°C.
 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

CM600E2Y-34H

HIGH POWER SWITCHING USE
INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

PERFORMANCE CURVES

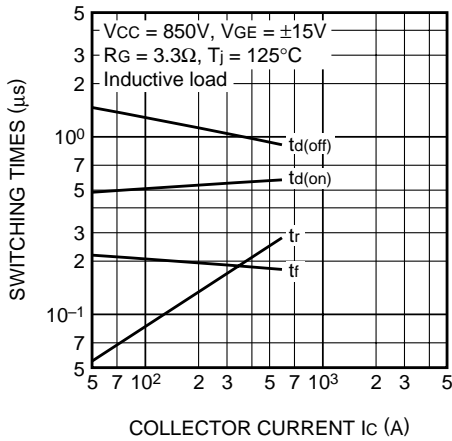


CM600E2Y-34H

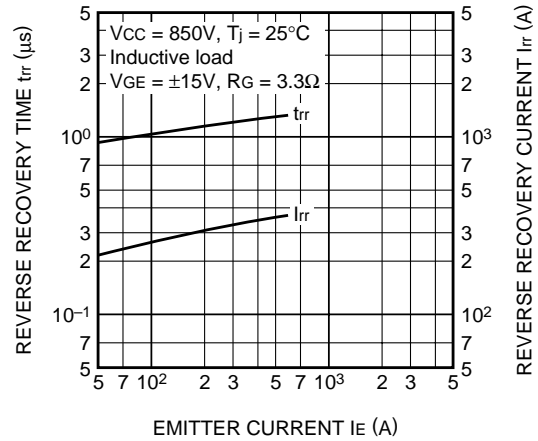
HIGH POWER SWITCHING USE
INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

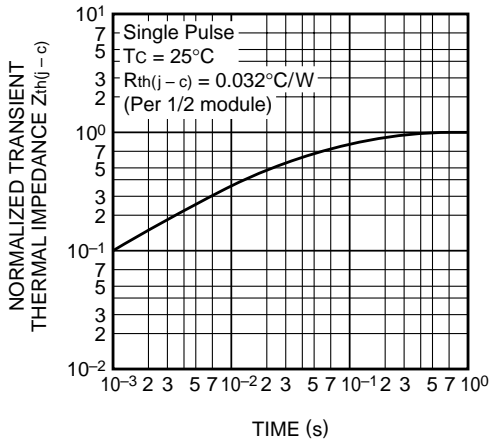
**HALF-BRIDGE
SWITCHING CHARACTERISTICS
(TYPICAL)**



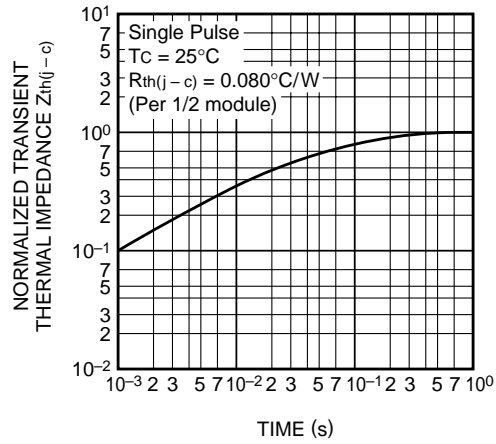
**REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT part)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDi part)**



**V_{GE} - GATE CHARGE
(TYPICAL)**

